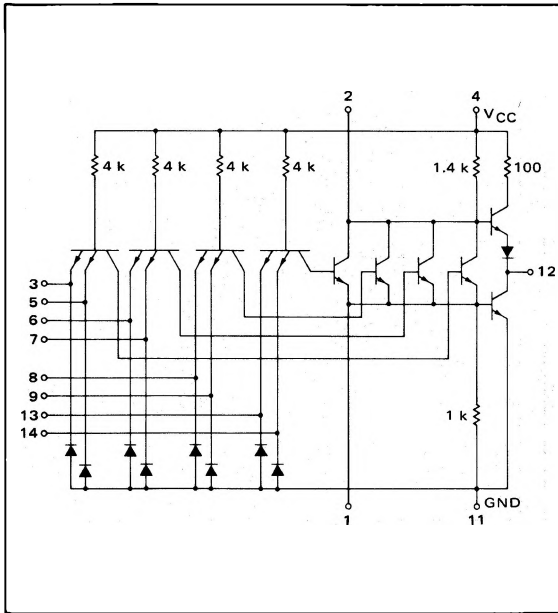


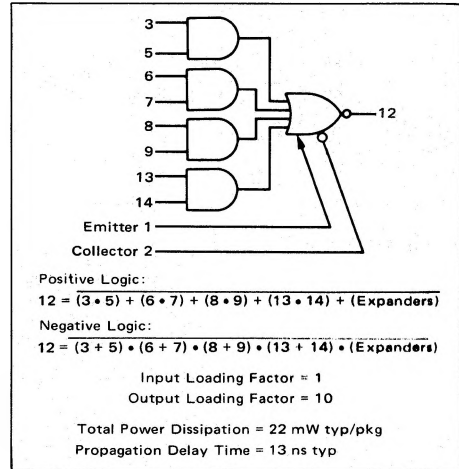
**EXPANDABLE 4-WIDE 2-INPUT  
"AND-OR-INVERT" GATE**

**MCBC5400/MCB5400F series**

**MCBC5453\*  
MCB5453F\***

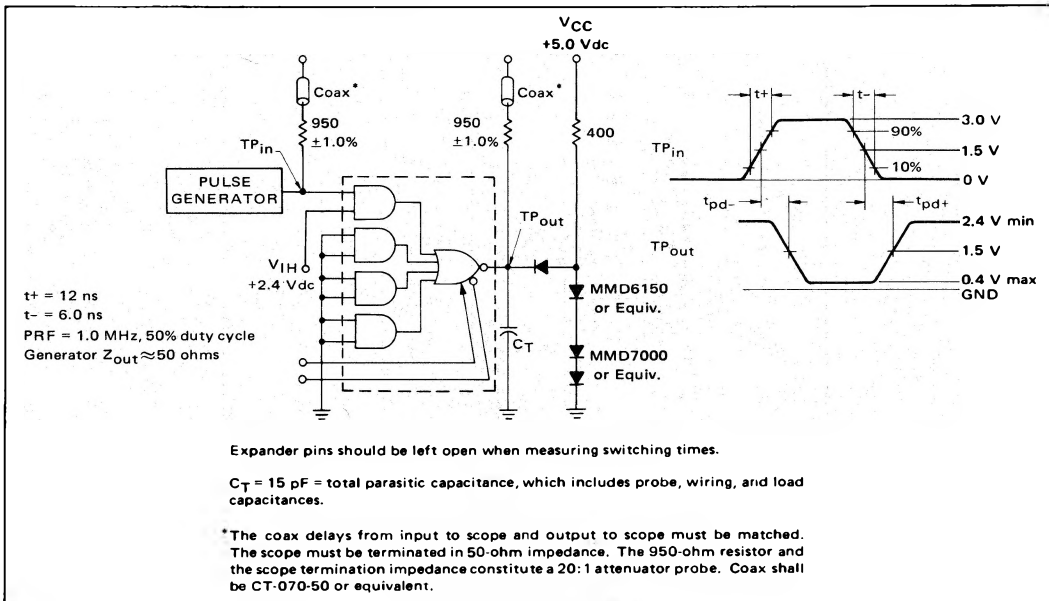


This device consists of four 2-input AND gates ORed together and inverted. Up to four MCB5460 expander gates may be ORed with the device at the expander points. Beam lead sealed junction technology is used to manufacture these devices. They are particularly useful in highly reliable systems using hybrid beam lead assembly techniques or standard flat package assembly techniques.



**SWITCHING TIME TEST CIRCUIT**

**VOLTAGE WAVEFORMS AND DEFINITIONS**



\*F suffix = 1/4" x 1/4" ceramic package (Case 651). MCBC-prefixed devices are unencapsulated. Beam numbers are the same as the pin numbers for flat-packaged devices. See General Information section for package and chip details.

FIGURE 1 –  $I_{EX}$  TEST CIRCUIT

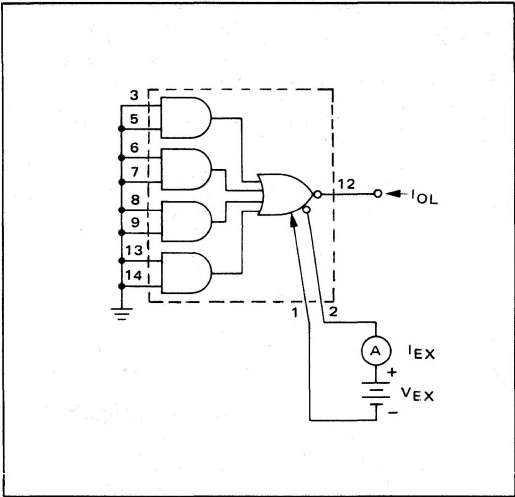


FIGURE 2 –  $V_{BE}$  TEST CIRCUIT

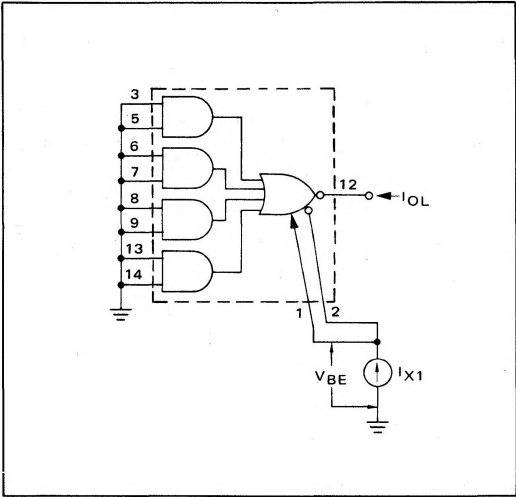
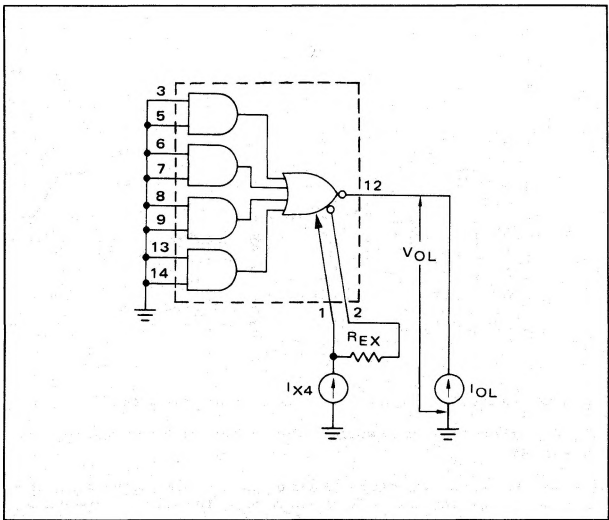


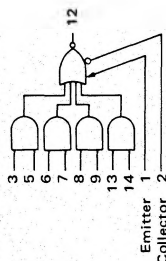
FIGURE 3 –  $V_{OL}$  TEST CIRCUIT



**MCBC5453, MCB5453F (continued)**

## ELECTRICAL CHARACTERISTICS

Test procedures are shown for one input of the device. To complete testing, sequence through remaining inputs in a similar manner.

[illegible]

\*\* Tested only at 25°C.

- ① See Figure 1.
- ② See Figure 2.
- ③ See Figure 3.